

Atty. Docket No. CPAC.1001-1  
Appl. No. 09/802,443



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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Rajendra D. PENDSE, *et al.*

Application No.: 09/802,443

Filed: March 9, 2001

Title: **Flip chip-in-leadframe package and  
process**

) Examiner: Deven M. Collins

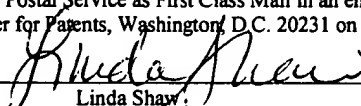
) Group Art Unit: 2823

) Date: June 28, 2002

) CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the  
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Commissioner for Patents, Washington, D.C. 20231 on June 28, 2002.

Signed

  
Linda Shaw

COMMISSIONER OF PATENTS  
WASHINGTON, D.C. 20231

PRELIMINARY AMENDMENT  
AND RESPONSE TO RESTRICTION REQUIREMENT

Dear Sir:

PRELIMINARY AMENDMENT

Preliminarily, kindly amend the application as follows:

In the drawings:

Amend Fig. 4 as shown in red ink on the accompanying copy of drawings sheet  
numbered 2/2.

RESPONSE TO RESTRICTION REQUIREMENT

Responsive to the Office Action mailed May 29, 2002 (Restriction Only), Applicants elect  
Group I, claims 1-14 for prosecution in this application.

REMARKS

Preliminary Amendment

Fig. 4 is amended to correct an obvious error made in preparation of formal drawings for  
this application. Particularly, in the formal drawings reference numeral 44 appears twice. By  
amendment herein, one of these is corrected to -- 49 --, as appears on the informal drawings as  
originally filed with the application. No new matter is introduced by this amendment, and entry